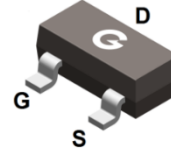
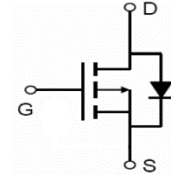


Features

- Advanced Trench technology
- Super low on-resistance
- Fast switching speed
- Excellent C_{dv}/d_t effect decline

HF



SOT-23-3L

Mechanical Data

- Case: SOT-23-3L
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BL3417-3L	SOT-23-3L	3000 pcs / Tape & Reel	3417

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DS}	-30	V
Gate-to-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_A = 25^\circ\text{C}$) ^{*1}	I_D	-5	A
Continuous Drain Current ($T_A = 100^\circ\text{C}$) ^{*1}		-3.1	A
Pulsed Drain Current ($t_p = 10\mu\text{s}$, $T_A = 25^\circ\text{C}$)	I_{DM}	-40	A
Single Pulse Avalanche Energy ^{*3}	E_{AS}	35	mJ
Power Dissipation ($T_A = 25^\circ\text{C}$) ^{*1}	P_D	1.25	W
Operating Junction Temperature Range	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance Junction-to-Air ^{*1}	$R_{\theta JA}$	-	-	100	$^\circ\text{C/W}$

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = -250μA	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -30V, V _{GS} = 0V	-	-	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V, V _{DS} = 0V	-	-	±100	nA
On Characteristics						
R _{DS(ON)}	Drain-Source On-resistance ^{*2}	V _{GS} = -10V, I _D = -5A	-	-	30	mΩ
		V _{GS} = -4.5V, I _D = -4A	-	-	40	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250μA	-1	-1.5	-2.5	V
Dynamic Characteristics						
C _{ISS}	Input Capacitance	V _{GS} = 0V	-	916	-	pF
C _{OSS}	Output Capacitance	V _{DS} = -15V	-	112	-	
C _{RSS}	Reverse Transfer Capacitance	f = 1.0MHz	-	101	-	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time ^{*4}	V _{GS} = -10V	-	8.2	-	ns
t _r	Turn-on Rise Time ^{*4}	V _{DD} = -15V	-	18.6	-	
t _{d(OFF)}	Turn-Off Delay Time ^{*4}	I _D = -10A	-	31.8	-	
t _f	Turn-Off Fall Time ^{*4}	R _G = 3Ω	-	18.4	-	
Q _G	Total Gate-Charge	V _{DD} = -15V	-	20	-	nC
Q _{GS}	Gate to Source Charge	V _{GS} = -10V	-	2.6	-	
Q _{GD}	Gate to Drain (Miller) Charge	I _D = -4A	-	3.3	-	
Source-Drain Diode Characteristics						
V _{SD}	Diode Forward Voltage ^{*2}	I _{SD} = -1A, V _{GS} = 0V	-	-	-1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} = -4A, V _{GS} = 0V	-	120	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt = 100A/μs	-	100	-	nC

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The E_{AS} data shows Max. rating. The test condition is $V_{DD} = -15V, V_{GS} = -10V, L = 0.5mH$
4. Guaranteed by design, not subject to production

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

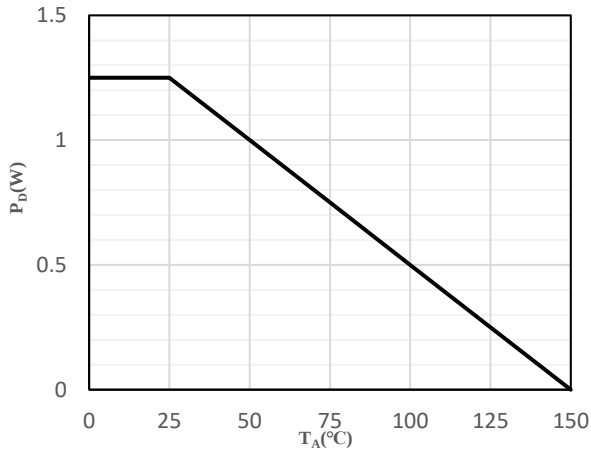


Fig 1 Power Dissipation

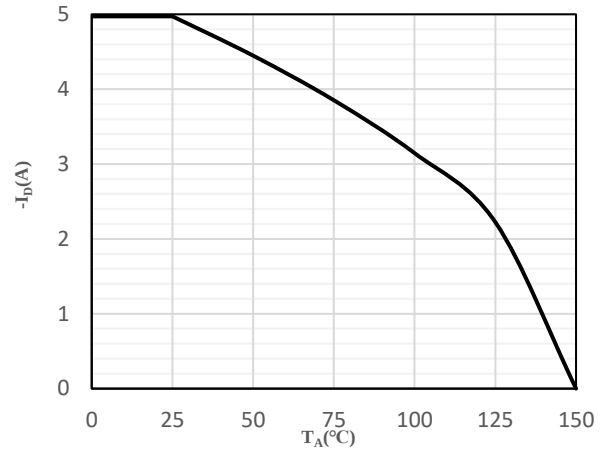


Fig 2 Drain Current

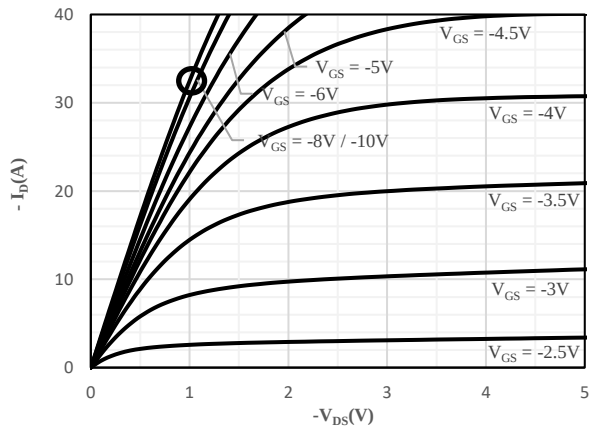


Fig 3 Typical Output Characteristics

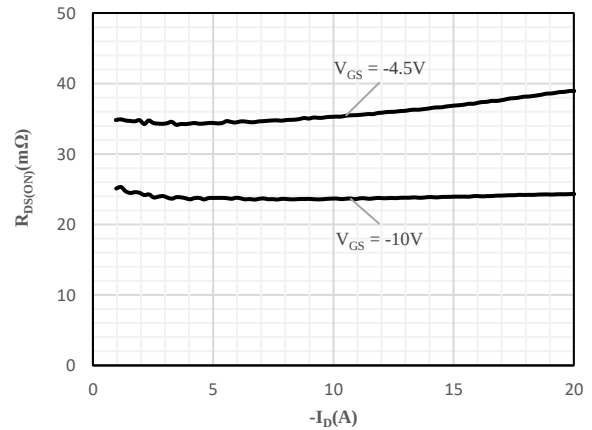


Fig 4 On-Resistance vs. Drain Current and Gate Voltage

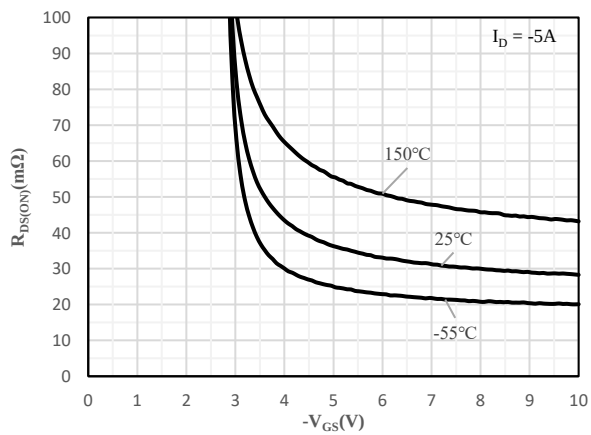


Fig 5 On-Resistance vs. Gate-Source Voltage

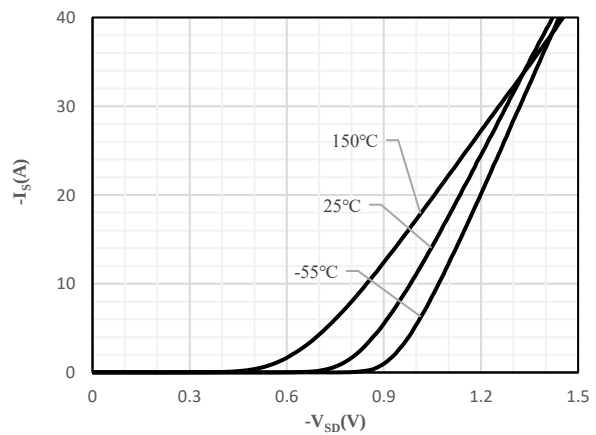


Fig 6 Body-Diode Characteristics

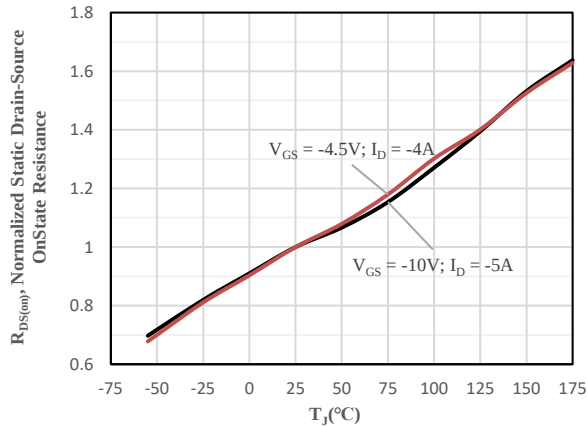


Fig 7 Normalized On-Resistance vs. Junction Temperature

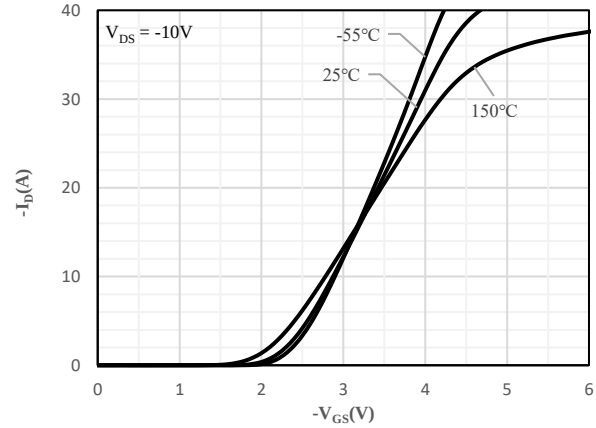


Fig 8 Transfer Characteristics

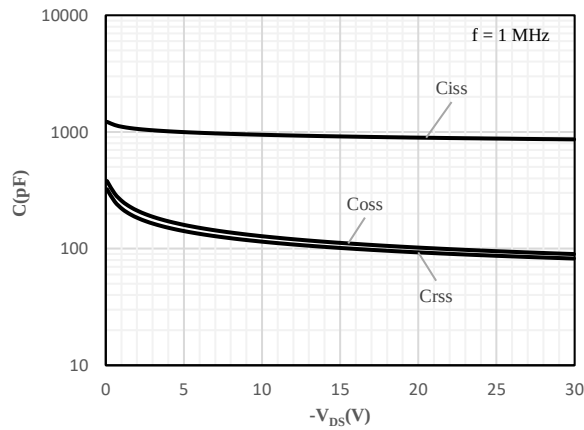


Fig 9 Capacitance Characteristics

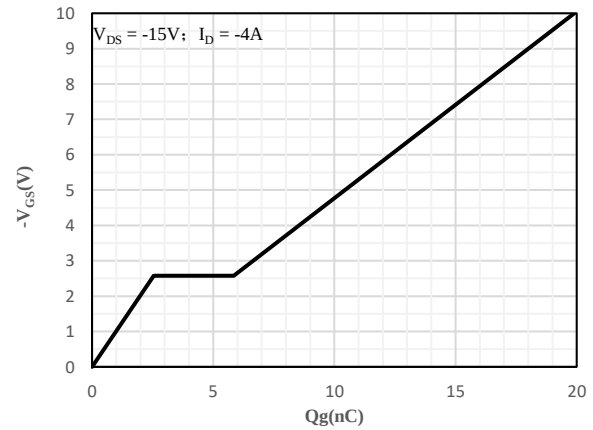


Fig 10 Gate-Charge Characteristics

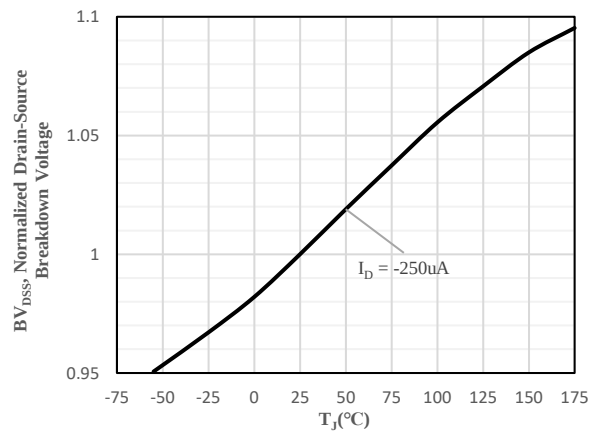


Fig 11 Normalized Breakdown Voltage vs. Junction Temperature

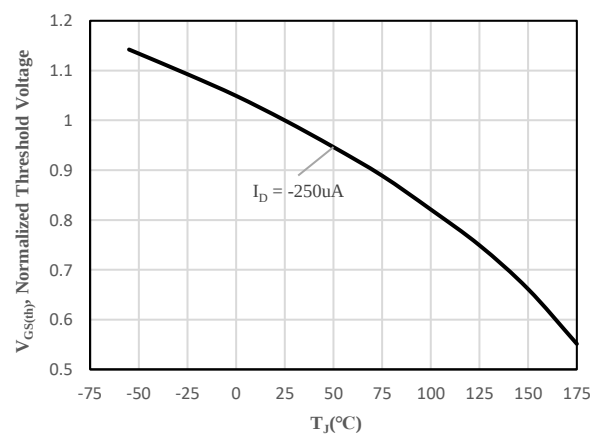
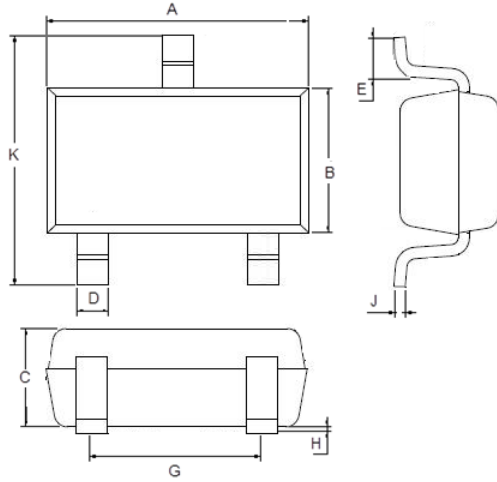


Fig 12 Normalized $V_{GS(th)}$ vs. Junction Temperature

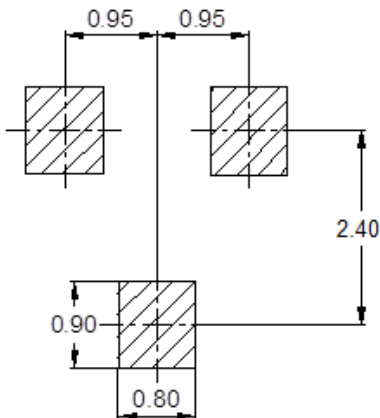
Package Outline Dimensions (Unit: mm)



SOT-23-3L		
Dimension	Min.	Max.
A	2.80	3.00
B	1.50	1.70
C	1.00	1.20
D	0.35	0.45
E	0.35	0.55
G	1.80	2.00
H	0.02	0.10
J	0.10	0.20
K	2.60	3.00

Mounting Pad Layout (Unit: mm)

SOT-23-3L



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